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UNITED STATES PATENT AND TRADEMARK OFFICE

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BEFORE THE PATENT TRIAL AND APPEAL BOARD

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INTEL CORPORATION, GLOBALFOUNDRIES U.S., INC.,  
MICRON TECHNOLOGY, INC., AND  
SAMSUNG ELECTRONICS COMPANY, LTD.,

Petitioners

v.

DANIEL L. FLAMM,

Patent Owner

CASE IPR2017-0392<sup>1</sup>  
U.S. Patent No. 5,711,849

**PATENT OWNER'S UPDATED EXHIBIT LIST**

Mail Stop: PATENT BOARD  
Patent Trial and Appeal Board  
U.S. Patent & Trademark Office  
P.O. Box 1450  
Alexandria, VA 22313-1450

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<sup>1</sup> Samsung Electronics Company, Ltd. was joined as a party to this proceeding via a Motion for Joinder in IPR2017-01747

**UPDATED EXHIBIT LIST**

Ex. 2001	David Edelson and Daniel L. Flamm, <i>Computer Simulation of a CF<sub>4</sub> Plasma Etching Silicon</i> , 56 J. APPLIED PHYSICS 1522 (1984)
Ex. 2002	I.C. Plumb and K.R. Ryan, <i>A Model of the Chemical Processes Occurring in CF<sub>4</sub>/O<sub>2</sub> Discharges Used in Plasma Etching</i> , 6 Plasma Chem. and Plasma Processing 205 (1986)
Ex. 2003	Declaration by Daniel L. Flamm
Ex. 2004	Declaration of Rolf O. Stadheim in Support of Patent Owner's Unopposed Motion for <i>Pro Hac Vice</i> Admission
Ex. 2005	Curriculum Vitae of Daniel L. Flamm, Sc.D.

Respectfully Submitted,

Date: March 6, 2018

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## CERTIFICATE OF SERVICE

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